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EMC1184

Quad Channel 1°C Temperature Sensor with Beta Compensation and 1.8V SMBus Communications

PRODUCT FEATURES

Datasheet

General Description

The EMC1184 is a high accuracy, low cost, 1.8V System Management Bus (SMBus) compatible temperature sensor. Advanced features such as Resistance Error Correction (REC), Beta Compensation (to support CPU diodes requiring the BJT/transistor model including 65nm and lower geometry processors) and automatic diode type detection combine to provide a robust solution for complex environmental monitoring applications. The ability to communicate at 1.8V SMBus levels provides compatible I/O for the advanced processors found in today's tablet and smartphone applications.

The EMC1184 monitors four temperature (three external and one internal) channels, providing $\pm 1^{\circ}$ C accuracy for both external and internal diode temperatures.

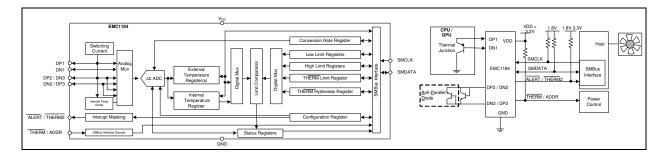
REC automatically eliminates the temperature error caused by series resistance allowing greater flexibility in routing thermal diodes. Frequency hopping* and analog filters ensure remote diode traces can be as far as eight (8) inches without degrading the signal. Beta Compensation eliminates temperature errors caused by low, variable beta transistors common in today's fine geometry processors. The automatic beta detection feature monitors the external diode/transistor and determines the optimum sensor settings for accurate temperature measurements regardless of processor technology. This frees the user from providing unique sensor configurations for each temperature monitoring application. These advanced features plus ±1°C measurement accuracy provide a low-cost, highly flexible and accurate solution for critical temperature monitoring applications.

Applications

- Notebook Computers
- Desktop Computers
- Industrial
- Embedded applications

Features

- Programmable SMBus address
- Support for diodes requiring the BJT/transistor model
 Supports 65pm and lower geometry CRIL thermal
 - Supports 65nm and lower geometry CPU thermal diodes
- Pin and register compatible with EMC1414
- Automatically determines external diode type and optimal settings
- Resistance Error Correction
- Frequency hops the remote sample frequency to reject DC converter and other coherent noise sources*
- Consecutive Alert queue to further reduce false Alerts
- Up to 3 External Temperature Monitors
- 25°C typ, ±1°C max accuracy (20°C < T_{DIODE} < 110°C)
 </p>
- 0.125°C resolution
- Supports up to 2.2nF diode filter capacitor
- Anti-parallel diodes for extra diode support Internal Temperature Monitor
 - ±1°C accuracy
 - 0.125°C resolution
- 3.3V Supply Voltage
- 1.8V SMBus operation
- Programmable temperature limits for ALERT/THERM2 (85°C default high limit and 0°C default low limit) and THERM (85°C default)
- Available in small 10-pin 3mm x 3mm DFN RoHS compliant package



* Technology covered under the US patent 7,193,543.

Datasheet

Ordering Information:

ORDERING NUMBER	PACKAGE	FEATURES	SMBUS ADDRESS
EMC1184-A-AIA-TR	10-pin DFN 3mm x 3mm (RoHS compliant)	Up to four temperature sensors, ALERT/ THERM2 and THERM pins, programmable SMBus address	Selectable via THERM pull-up

This product meets the halogen maximum concentration values per IEC61249-2-21 For RoHS compliance and environmental information, please visit www.smsc.com/rohs

Please contact your SMSC sales representative for additional documentation related to this product such as application notes, anomaly sheets, and design guidelines.

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Chapter 1 Block Diagram

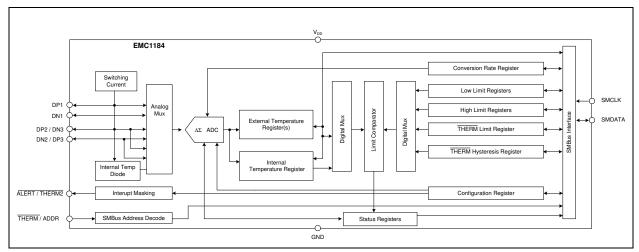


Figure 1.1 EMC1184 Block Diagram

Chapter 2 Pin Description

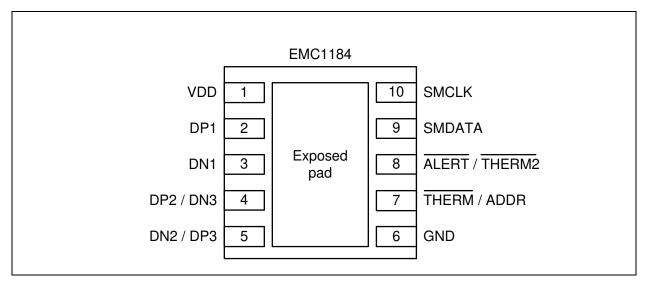


Figure 2.1 EMC1184 Pin Diagram DFN-10

Table 2.1 EMC1184 Pin Description

PIN NUMBER	NAME	FUNCTION	TYPE
1	VDD	Power supply	Power
2	DP1	External diode 1 positive (anode) connection	AIO
3	DN1	External diode 1 negative (cathode) connection	AIO
4	DP2 / DN3	External diode 2 positive (anode) connection / External Diode 3 negative (cathode) connection for anti-parallel diodes	AIO
5	DN2 / DP3	External diode 2 negative (cathode) connection / External Diode 3 positive (anode) connection for anti-parallel diodes	AIO
6	GND	Ground	Power
7	THERM / ADDR	THERM - Critical THERM output signal - requires pull-up resistor	OD (5V)
/ THERM / ADDR	ADDR - Selects SMBus address based on pull-up resistor	OD (5V)	
8	ALERT / THERM2	Active low digital ALERT output signal - requires pull-up resist	OD (5V)

Table 2.1 EMC1184 Pin Description (continued)

PIN NUMBER	NAME	FUNCTION	TYPE
9	SMDATA	SMBus Data input/output - requires pull-up resistor	DIOD (5V)
10	SMCLK	SMBus Clock input - requires pull-up resistor	DI (5V)
Bottom Pad	Exposed Pad	Not internally connected, but recommend grounding.	-

The pin types are described Table 2.2.

Table 2.2 Pin Types

PIN TYPE	DESCRIPTION						
Power	This pin is used to supply power or ground to the device.						
AIO	Analog Input / Output -This pin is used as an I/O for analog signals.						
DI	Digital Input - This pin is used as a digital input. This pin is 5V tolerant.						
DIOD	Digital Input / Open Drain Output - This pin is used as a digital I/O. When it is used as an output, it is open drain and requires a pull-up resistor. This pin is 5V tolerant.						
OD	Open Drain Digital Output - This pin is used as a digital output. It is open drain and requires a pull-up resistor. This pin is 5V tolerant.						

Chapter 3 Electrical Specifications

3.1 Absolute Maximum Ratings

Table 3.1 Absolute Maximum Ratings

DESCRIPTION	RATING	UNIT
Supply Voltage (V _{DD})	-0.3 to 4.0	V
Voltage on 5V tolerant pins (V _{5VT_pin})	-0.3 to 5.5	V
Voltage on 5V tolerant pins (V _{5VT_pin} - V _{DD}) (see Note 3.1)	0 to 3.6	V
Voltage on any other pin to Ground	-0.3 to V _{DD} +0.3	V
Operating Temperature Range	-40 to +125	°C
Storage Temperature Range	-55 to +150	°C
Lead Temperature Range	Refer to JEDEC Spec. J-STD-020	
Package Thermal Characteristics for DFN-10		
Thermal Resistance (θ _{j-a})	77.1	°C/W
ESD Rating, All pins HBM	2000	V

Note: Stresses at or above those listed could cause permanent damage to the device. This is a stress rating only and functional operation of the device at any other condition above those indicated in the operation sections of this specification is not implied.

Note 3.1 For the 5V tolerant pins that have a pull-up resistor (SMCLK, SMDATA, THERM, and ALERT / THERM2), the pull-up voltage must not exceed 3.6V when the device is unpowered.

3.2 Electrical Specifications

Table 3.2 Electrical Specifications

$V_{DD} = 3.0 V$ to 3.6V, $T_A = -40 ^{\circ} C$ to 125 $^{\circ} C$, all typical values at $T_A = 27 ^{\circ} C$ unless otherwise noted.								
CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNITS	CONDITIONS		
DC Power								
Supply Voltage	V _{DD}	3.0	3.3	3.6	V			
Supply Current	I _{DD}		200	410	μΑ	0.0625 conversion / sec, dynamic averaging disabled		
			215	425	μΑ	1 conversion / sec, dynamic averaging disabled		

Table 3.2 Electrical Specifications (continued)

$V_{DD} = 3.0V \text{ to } 3.6$	$V, T_A = -40^{\circ}$	C to 125	s°C, all typ	oical value	es at T _A =	27°C unless otherwise noted.
CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNITS	CONDITIONS
			325	465	μΑ	4 conversions / sec, dynamic averaging disabled
			890	1050	μΑ	4 conversions / sec, dynamic averaging enabled
			1120		μΑ	≥ 16 conversions / sec, dynamic averaging enabled
Standby Supply Current	I _{DD}		170	230	μА	Device in Standby mode, no SMBus communications, ALERT and THERM pins not asserted.
		Inter	nal Temp	erature M	onitor	
Temperature Accuracy			±0.25	±1	°C	-5°C < T _A < 100°C
				±2	°C	-40°C < T _A < 125°C
Temperature Resolution			0.125		°C	
		Exte	rnal Temp	erature M	lonitor	
Temperature Accuracy			±0.25	±1	°C	+20°C < T _{DIODE} < +110°C 0°C < T _A < 100°C
			±0.5	±2	°C	-40°C < T _{DIODE} < 127°C
Temperature Resolution			0.125		°C	
Conversion Time all Channels	t _{CONV}		150		ms	default settings
Capacitive Filter	C _{FILTER}		2.2	2.7	nF	Connected across external diode
	,	ALERT /	THERM	and THE	RM pins	
Output Low Voltage	V _{OL}	0.4			V	I _{SINK} = 8mA
Leakage Current	I _{LEAK}			±5	μА	ALERT / THERM2 and THERM pins Device powered or unpowered T _A < 85°C pull-up voltage ≤ 3.6V

3.3 SMBus Electrical Characteristics

Table 3.3 SMBus Electrical Specifications

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNITS	CONDITIONS
			SMBus	Interface		
Input High Voltage	V _{IH}	1.4		V _{DD}	V	5V Tolerant. Voltage threshold based on 1.8V operation
Input Low Voltage	V _{IL}	-0.3		0.8	V	5V Tolerant. Voltage threshold based on 1.8V operation
Leakage Current	I _{LEAK}			±5	μΑ	Powered or unpowered TA < 85°C
Hysteresis		50			mV	
Input Capacitance	C _{IN}		5		pF	
Output Low Sink Current	I _{OL}	8.2		15	mA	SMDATA = 0.4V
			SMBus	Timing		
Clock Frequency	f _{SMB}	10		400	kHz	
Spike Suppression	t _{SP}			50	ns	
Bus Free Time Stop to Start	t _{BUF}	1.3			μѕ	
Hold Time: Start	t _{HD:STA}	0.6			μs	
Setup Time: Start	t _{SU:STA}	0.6			μs	
Setup Time: Stop	t _{SU:STO}	0.6			μs	
Data Hold Time	t _{HD:DAT}	0			μs	When transmitting to the master
Data Hold Time	t _{HD:DAT}	0.3			μs	When receiving from the master
Data Setup Time	t _{SU:DAT}	100			ns	
Clock Low Period	t _{LOW}	1.3			μs	
Clock High Period	t _{HIGH}	0.6			μs	
Clock/Data Fall time	t _{FALL}			300	ns	Min = 20+0.1C _{LOAD} ns
Clock/Data Rise time	t _{RISE}			300	ns	$Min = 20+0.1C_{LOAD} ns$
Capacitive Load	C _{LOAD}			400	pF	per bus line
Timeout	t _{TIMEOUT}	25		35	ms	Disabled by default

Chapter 4 System Management Bus Interface Protocol

4.1 Communications Protocol

The EMC1184 communicates with a host controller, such as an SMSC SIO, through the SMBus. The SMBus is a two-wire serial communication protocol between a computer host and its peripheral devices. A detailed timing diagram is shown in Figure 4.1.

For the first 15ms after power-up the device may not respond to SMBus communications.

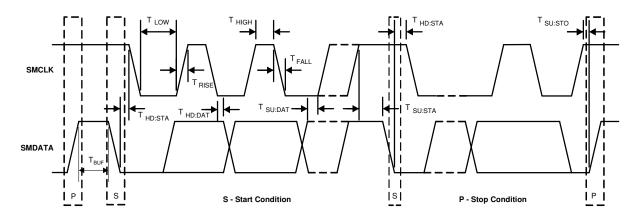


Figure 4.1 SMBus Timing Diagram

4.1.1 SMBus Start Bit

The SMBus Start bit is defined as a transition of the SMBus Data line from a logic '1' state to a logic '0' state while the SMBus Clock line is in a logic '1' state.

4.1.2 SMBus Address and RD / $\overline{\text{WR}}$ Bit

The SMBus Address Byte consists of the 7-bit client address followed by the RD / \overline{WR} indicator bit. If this RD / \overline{WR} bit is a logic '0', the SMBus Host is writing data to the client device. If this RD / \overline{WR} bit is a logic '1', the SMBus Host is reading data from the client device.

The EMC1183-A and EMC1184-A SMBus slave address is determined by the pull-up resistor on the THERM pin as shown in Table 4.1, "SMBus Address Decode".

The Address decode is performed by pulling known currents from VDD through the external resistor causing the pin voltage to drop based on the respective current / resistor relationship. This pin voltage is compared against a threshold that determines the value of the pull-up resistor.

PU <u>LL UP R</u> ESISTOR ON THERM PIN (±5%)	SMBUS ADDRESS
4.7k	1111_100(r/ w)b
6.8k	1011_100(r/w)b

Table 4.1 SMBus Address Decode

PU <u>LL UP R</u> ESISTOR ON THERM PIN (±5%)	SMBUS ADDRESS
10k	1001_100(r/w)b
15k	1101_100(r/w)b
22k	0011_100(r/w)b
33k	0111_100(r/w)b

Table 4.1 SMBus Address Decode (continued)

4.1.3 THERM Pin Considerations

Because of the decode method used to determine the SMBus Address, it is important that the pull-up resistance on the THERM pin be within the tolerances shown in Table 4.1. Additionally, the pull-up resistor on the THERM pin must be connected to the same 3.3V supply that drives the VDD pin.

For 15ms after power up, the THERM pin must not be pulled low or the SMBus address will not be decoded properly. If the system requirements do not permit these conditions, the THERM pin must be isolated from its hard-wired OR'd bus during this time.

One method of isolating this pin is shown in Figure 4.4, "Isolating the THERM pin".

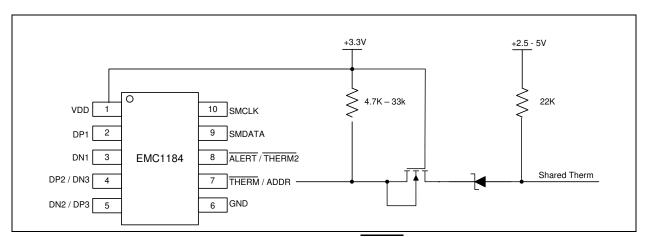


Figure 4.4 Isolating the THERM pin

4.1.5 SMBus Data Bytes

All SMBus Data bytes are sent most significant bit first and composed of 8-bits of information.

4.1.6 SMBus ACK and NACK Bits

The SMBus client will acknowledge all data bytes that it receives. This is done by the client device pulling the SMBus data line low after the 8th bit of each byte that is transmitted. This applies to the Write Byte protocol.

The Host will NACK (not acknowledge) the last data byte to be received from the client by holding the SMBus data line high after the 8th data bit has been sent.

4.1.7 SMBus Stop Bit

The SMBus Stop bit is defined as a transition of the SMBus Data line from a logic '0' state to a logic '1' state while the SMBus clock line is in a logic '1' state. When the device detects an SMBus Stop bit and it has been communicating with the SMBus protocol, it will reset its client interface and prepare to receive further communications.

4.1.8 SMBus Timeout

The EMC1184 supports SMBus Timeout. If the clock line is held low for longer than t_{TIMEOUT}, the device will reset its SMBus protocol. This function can be enabled by setting the TIMEOUT bit (see Section 6.12, "Consecutive ALERT Register 22h").

4.1.9 SMBus and I²C Compatibility

The EMC1184 is compatible with SMBus and I^2C . The major differences between SMBus and I^2C devices are highlighted here. For more information, refer to the SMBus 2.0 and I^2C specifications. For information on using the EMC1184 in an I^2C system, refer to SMSC AN 14.0 SMSC Dedicated Slave Devices in I^2C Systems.

- 1. EMC1184 supports I²C fast mode at 400kHz. This covers the SMBus max time of 100kHz.
- 2. Minimum frequency for SMBus communications is 10kHz.
- 3. The SMBus client protocol will reset if the clock is held at a logic '0' for longer than 30ms. This timeout functionality is disabled by default in the EMC1184 and can be enabled by writing to the TIMEOUT bit. I²C does not have a timeout.
- 4. I²C devices do not support the Alert Response Address functionality (which is optional for SMBus).

Attempting to communicate with the EMC1184 SMBus interface with an invalid slave address or invalid protocol will result in no response from the device and will not affect its register contents. Stretching of the SMCLK signal is supported, provided other devices on the SMBus control the timing.

4.2 SMBus Protocols

The device supports Send Byte, Read Byte, Write Byte, Receive Byte, and the Alert Response Address as valid protocols as shown below.

All of the below protocols use the convention in Table 4.1.

Table 4.1 Protocol Format

DATA SENT	DATA SENT TO
TO DEVICE	THE HOST
# of bits sent	# of bits sent

4.2.1 Write Byte

The Write Byte is used to write one byte of data to the registers, as shown in Table 4.2.

Table 4.2 Write Byte Protocol

START	SLAVE ADDRESS	WR	ACK	REGISTER ADDRESS	ACK	REGISTER DATA	ACK	STOP
1 -> 0	YYYY_YYY	0	0	XXh	0	XXh	0	0 -> 1

4.2.2 Read Byte

The Read Byte protocol is used to read one byte of data from the registers as shown in Table 4.3.

Table 4.3 Read Byte Protocol

START	SLAVE ADDRESS	WR	ACK	REGISTER ADDRESS	ACK	START	SLAVE ADDRESS	RD	ACK	REGISTER DATA	NACK	STOP
1 -> 0	YYYY_ YYY	0	0	XXh	0	1 -> 0	YYYY_ YYY	1	0	XX	1	0 -> 1

4.2.3 Send Byte

The Send Byte protocol is used to set the internal address register pointer to the correct address location. No data is transferred during the Send Byte protocol as shown in Table 4.4.

Table 4.4 Send Byte Protocol

START	SLAVE ADDRESS	WR	ACK	REGISTER ADDRESS	ACK	STOP
1 -> 0	YYYY_YYY	0	0	XXh	0	0 -> 1

4.2.4 Receive Byte

The Receive Byte protocol is used to read data from a register when the internal register address pointer is known to be at the right location (e.g. set via Send Byte). This is used for consecutive reads of the same register as shown in Table 4.5.

Table 4.5 Receive Byte Protocol

START	SLAVE ADDRESS	RD	ACK	REGISTER DATA	NACK	STOP
1 -> 0	YYYY_YYY	1	0	XXh	1	0 -> 1

4.3 Alert Response Address

The ALERT output can be used as a processor interrupt or as an SMBus Alert.

When it detects that the ALERT pin is asserted, the host will send the Alert Response Address (ARA) to the general address of 0001_100xb. All devices with active interrupts will respond with their client address as shown in Table 4.6.

Table 4.6 Alert Response Address Protocol

START	ALERT RESPONSE ADDRESS	RD	ACK	DEVICE ADDRESS	NACK	STOP
1 -> 0	0001_100	1	0	YYYY_YYY	1	0 -> 1

The EMC1184 will respond to the ARA in the following way:

- 1. Send Slave Address and verify that full slave address was sent (i.e. the SMBus communication from the device was not prematurely stopped due to a bus contention event).
- 2. Set the MASK_ALL bit to clear the ALERT pin.

APPLICATION NOTE: The ARA does not clear the Status Register and if the MASK_ALL bit is cleared prior to the Status Register being cleared, the ALERT pin will be reasserted.

Chapter 5 Product Description

The EMC1184 is an SMBus temperature sensor. The EMC1184 monitors one internal diode and up to three externally connected temperature diodes.

Thermal management is performed in cooperation with a host device. This consists of the host reading the temperature data of both the external and internal temperature diodes of the EMC1184 and using that data to control the speed of one or more fans.

The EMC1184 has two levels of monitoring. The first provides a maskable ALERT / THERM2 signal to the host when the measured temperatures exceeds user programmable limits. This allows the EMC1184 to be used as an independent thermal watchdog to warn the host of temperature hot spots without direct control by the host. The second level of monitoring provides a non-maskable interrupt on the THERM pin if the measured temperatures meet or exceed a second programmable limit.

For the EMC1184, External Diode channels 2 and 3 are only compatible with general purpose diodes (such as a 2N3904).

Figure 5.1 shows a system level block diagram of the EMC1184.

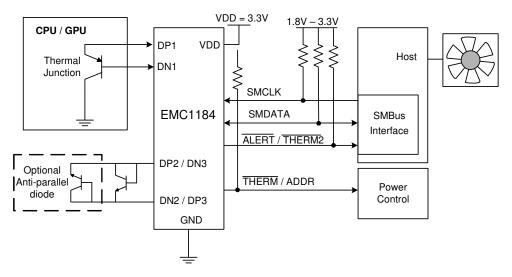


Figure 5.1 System Diagram for EMC1184

5.1 Modes of Operation

The EMC1184 has two modes of operation.

- Active (Run) In this mode of operation, the ADC is converting on all temperature channels at the programmed conversion rate. The temperature data is updated at the end of every conversion and the limits are checked. In Active mode, writing to the one-shot register will do nothing.
- Standby (Stop) In this mode of operation, the majority of circuitry is powered down to reduce supply current. The temperature data is not updated and the limits are not checked. In this mode of operation, the SMBus is fully active and the part will return requested data. Writing to the one-shot register will enable the device to update all temperature channels. Once all the channels are updated, the device will return to the Standby mode.

5.2 Conversion Rates

The EMC1184 may be configured for different conversion rates based on the system requirements. The conversion rate is configured as described in Section 6.5. The default conversion rate is 4 conversions per second. Other available conversion rates are shown in Table 6.6, "Conversion Rate".

5.3 Dynamic Averaging

Dynamic averaging causes the EMC1184 to measure the external diode channels for an extended time based on the selected conversion rate. This functionality can be disabled for increased power savings at the lower conversion rates (see Section 6.4, "Configuration Register 03h / 09h"). When dynamic averaging is enabled, the device will automatically adjust the sampling and measurement time for the external diode channels. This allows the device to average 2x or 16x longer than the normal 11 bit operation (nominally 21ms per channel) while still maintaining the selected conversion rate. The benefits of dynamic averaging are improved noise rejection due to the longer integration time as well as less random variation of the temperature measurement.

When enabled, the dynamic averaging applies when a one-shot command is issued. The device will perform the desired averaging during the one-shot operation according to the selected conversion rate.

When enabled, the dynamic averaging will affect the average supply current based on the chosen conversion rate as shown in Table 5.1.

	AVERAGE SUPPLY CURRENT (TYPICAL)		AVERAGING FACT 11-BIT OPE	
CONVERSION RATE	ENABLED (DEFAULT)	DISABLED	ENABLED (DEFAULT)	DISABLED
1 / 16 sec	230uA	220uA	16x	1x
1 / 8 sec	275uA	220uA	16x	1x
1 / 4 sec	350uA	220uA	16x	1x
1 / 2 sec	405uA	220uA	16x	1x
1 / sec	480uA	250uA	8x	1x
2 / sec	850uA	290uA	4x	1x
4 / sec (default)	890uA	370uA	2x	1x
8 / sec	970uA	525uA	1x	1x
16 / sec	990uA	690uA	0.5x	0.5x
32 / sec	1030uA	1050uA	0.25x	0.25x
64 / sec	1500uA	1100uA	0.125x	0.125x

Table 5.1 Supply Current vs. Conversion Rate for EMC1184

5.4 THERM Output

The THERM output is asserted independently of the ALERT output and cannot be masked. Whenever any of the measured temperatures exceed the user programmed Therm Limit values for the programmed number of consecutive measurements, the THERM output is asserted. Once it has been

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asserted, it will remain asserted until all measured temperatures drop below the Therm Limit minus the Therm Hysteresis (also programmable).

When the THERM pin is asserted, the THERM status bits will likewise be set. Reading these bits will not clear them until the THERM pin is deasserted. Once the THERM pin is deasserted, the THERM status bits will be automatically cleared.

5.4.1 THERM Pin Considerations

Because of the decode method used to determine the SMBus Address, it is important that the pull-up resistance on $\overline{\text{THERM}}$ pin be within $\pm 10\%$ tolerance. Additionally, the pull-up resistor on the $\overline{\text{THERM}}$ pin must be connected to the same 3.3V supply that drives the VDD pin.

For 15ms after power up, the THERM pin must not be pulled low or the SMBus Address will not be decoded properly. If the system requirements do not permit these conditions, the THERM pin must be isolated from the bus during this time. One method of isolating this pin is shown in Figure 5.2.

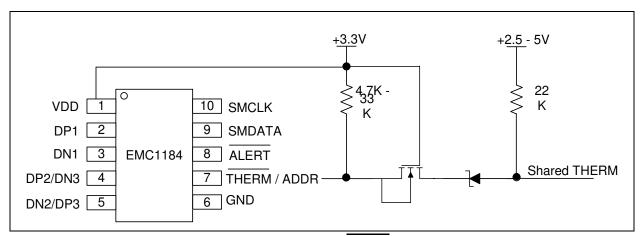


Figure 5.2 Isolating THERM Pin

5.5 ALERT / THERM2 Output

The ALERT / THERM2 pin is an open drain output and requires a pull-up resistor to V_{DD} and has two modes of operation: interrupt mode and comparator mode. The mode of the ALERT / THERM2 output is selected via the ALERT / COMPALERT/THERM bit in the Configuration Register (see Section 6.4).

5.5.1 ALERT / THERM2 Pin InterruptALERT Mode

When configured to operate in interrupt mode, the ALERT / THERM2 pin asserts low when an out of limit measurement (≥ high limit or < low limit) is detected on any diode or when a diode fault is detected, functioning as any standard ALERT in on the SMBus. The ALERT / THERM2 pin will remain asserted as long as an out-of-limit condition remains. Once the out-of-limit condition has been removed, the ALERT / THERM2 pin will remain asserted until the appropriate status bits are cleared.

The ALERT/ THERM2 pin can be masked by setting the MASK_ALL bit. Once the ALERT / THERM2 pin has been masked, it will be de-asserted and remain de-asserted until the MASK_ALL bit is cleared by the user. Any interrupt conditions that occur while the ALERT / THERM2 pin is masked will update the Status Register normally. There are also individual channel masks (see Section 6.11).

The $\overline{\text{ALERT}}$ / $\overline{\text{THERM2}}$ pin is used as an interrupt signal or as an SMBus Alert signal that allows an SMBus slave to communicate an error condition to the master. One or more $\overline{\text{ALERT}}$ / $\overline{\text{THERM2}}$ outputs can be hard-wired together.

5.5.2 ALERT / THERM2 Pin ComparatorTHERM Mode

When the ALERT / THERM2 pin is configured to operate in comparator mode, it will be asserted if any of the measured temperatures exceeds the respective high limit, acting as a second THERM function in. The ALERT / THERM2 pin will remain asserted until all temperatures drop below the corresponding high limit minus the Therm Hysteresis value.

When the $\overline{\text{ALERT}}$ / $\overline{\text{THERM2}}$ pin is asserted in comparator mode, the corresponding high limit status bits will be set. Reading these bits will not clear them until the $\overline{\text{ALERT}}$ / $\overline{\text{THERM2}}$ pin is deasserted. Once the $\overline{\text{ALERT}}$ pin is deasserted, the status bits will be automatically cleared.

The MASK_ALL bit will not block the ALERT / THERM2 pin in this mode; however, the individual channel masks (see Section 6.11) will prevent the respective channel from asserting the ALERT/THERM2 pin.

5.6 Temperature Measurement

The EMC1184 can monitor the temperature of up to three externally connected diodes.

The device contains programmable High, Low, and Therm limits for all measured temperature channels. If the measured temperature goes below the Low limit or above the High limit, the ALERT pin can be asserted (based on user settings). If the measured temperature meets or exceeds the Therm Limit, the THERM pin is asserted unconditionally, providing two tiers of temperature detection.

5.6.1 Beta Compensation

The EMC1184 is configured to monitor the temperature of basic diodes (e.g., 2N3904) or CPU thermal diodes. It automatically detects the type of external diode (CPU diode or diode connected transistor) and determines the optimal setting to reduce temperature errors introduced by beta variation. Compensating for this error is also known as implementing the transistor or BJT model for temperature measurement.

For discrete transistors configured with the collector and base shorted together, the beta is generally sufficiently high such that the percent change in beta variation is very small. For example, a 10% variation in beta for two forced emitter currents with a transistor whose ideal beta is 50 would contribute approximately 0.25°C error at 100°C. However for substrate transistors where the base-emitter junction is used for temperature measurement and the collector is tied to the substrate, the proportional beta variation will cause large error. For example, a 10% variation in beta for two forced emitter currents with a transistor whose ideal beta is 0.5 would contribute approximately 8.25°C error at 100°C.

For the EMC1184 the External Diode 2 and External Diode 3 channels do not support Beta Compensation.

5.6.2 Resistance Error Correction (REC)

Parasitic resistance in series with the external diodes will limit the accuracy obtainable from temperature measurement devices. The voltage developed across this resistance by the switching diode currents cause the temperature measurement to read higher than the true temperature. Contributors to series resistance are PCB trace resistance, on die (i.e. on the processor) metal resistance, bulk resistance in the base and emitter of the temperature transistor. Typically, the error caused by series resistance is +0.7°C per ohm. The EMC1184 automatically corrects up to 100 ohms of series resistance.

5.6.3 Programmable External Diode Ideality Factor

The EMC1184 is designed for external diodes with an ideality factor of 1.008. Not all external diodes, processor or discrete, will have this exact value. This variation of the ideality factor introduces error in the temperature measurement which must be corrected for. This correction is typically done using programmable offset registers. Since an ideality factor mismatch introduces an error that is a function

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of temperature, this correction is only accurate within a small range of temperatures. To provide maximum flexibility to the user, the EMC1184 provides a 6-bit register for each external diode where the ideality factor of the diode used is programmed to eliminate errors across all temperatures.

APPLICATION NOTE: When monitoring a substrate transistor or CPU diode and beta compensation is enabled, the Ideality Factor should not be adjusted. Beta Compensation automatically corrects for most ideality errors.

5.7 Diode Faults

The EMC1184 detects an open on the DP and DN pins, and a short across the DP and DN pins. For each temperature measurement made, the device checks for a diode fault on the external diode channel(s). When a diode fault is detected, the \overline{ALERT} / $\overline{THERM2}$ pin asserts (unless masked, see Section 5.8) and the temperature data reads 00h in the MSB and LSB registers (note: the low limit will not be checked). A diode fault is defined as one of the following: an open between DP and DN, a short from V_{DD} to DP, or a short from V_{DD} to DN.

If a short occurs across \overline{DP} and DN or a short occurs from DP to GND, the low limit status bit is set and the \overline{ALERT} / $\overline{THERM2}$ pin asserts (unless masked). This condition is indistinguishable from a temperature measurement of 0.000°C (-64°C in extended range) resulting in temperature data of 00h in the MSB and LSB registers.

If a short from DN to GND occurs (with a diode connected), temperature measurements will continue as normal with no alerts.

5.8 Consecutive Alerts

The EMC1184 contains multiple consecutive alert counters. One set of counters applies to the ALERT / THERM2 pin and the second set of counters applies to the THERM pin. Each temperature measurement channel has a separate consecutive alert counter for each of the ALERT / THERM2 and THERM pins. All counters are user programmable and determine the number of consecutive measurements that a temperature channel(s) must be out-of-limit or reporting a diode fault before the corresponding pin is asserted.

See Section 6.12, "Consecutive ALERT Register 22h" for more details on the consecutive alert function.

5.9 Digital Filter

To reduce the effect of noise and temperature spikes on the reported temperature, the External Diode 1 channel uses a programmable digital filter. This filter can be configured as Level 1, Level 2, or Disabled (default) (see Section 6.18). The typical filter performance is shown in Figure 5.4 and Figure 5.5.

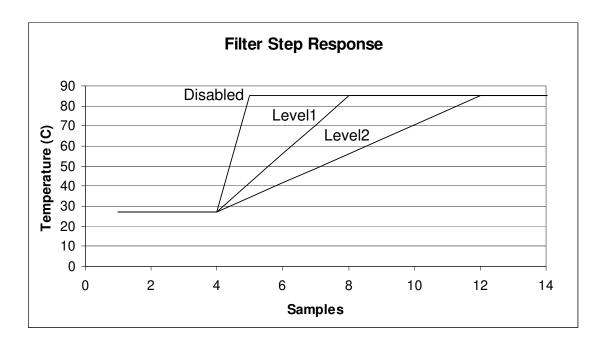


Figure 5.4 Temperature Filter Step Response

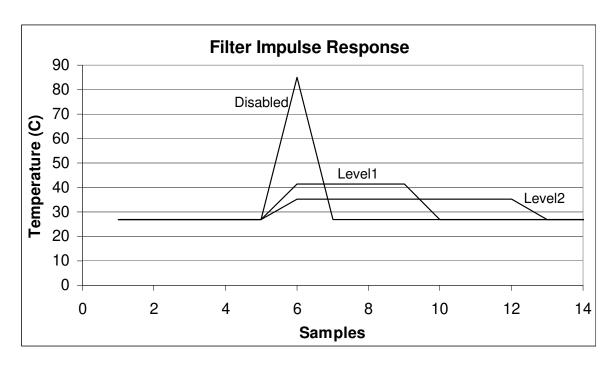


Figure 5.5 Temperature Filter Impulse Response

5.10 Temperature Measurement Results and Data

The temperature measurement results are stored in the internal and external temperature registers. These are then compared with the values stored in the high and low limit registers. Both external and internal temperature measurements are stored in 11-bit format with the eight (8) most significant bits stored in a high byte register and the three (3) least significant bits stored in the three (3) MSB positions of the low byte register. All other bits of the low byte register are set to zero.

The EMC1184 has two selectable temperature ranges. The default range is from 0° C to +127°C and the temperature is represented as binary number able to report a temperature from 0° C to +127.875°C in 0.125°C steps.

The extended range is an extended temperature range from -64° C to $+191^{\circ}$ C. The data format is a binary number offset by 64° C. The extended range is used to measure temperature diodes with a large known offset (such as AMD processor diodes) where the diode temperature plus the offset would be equivalent to a temperature higher than $+127^{\circ}$ C.

Table 5.2 shows the default and extended range formats.

Table 5.2 Temperature Data Format

TEMPERATURE (°C)	DEFAULT RANGE 0°C TO 127°C	EXTENDED RANGE -64°C TO 191°C
Diode Fault	000 0000 0000	000 0000 0000
-64	000 0000 0000	000 0000 0000
-1	000 0000 0000	001 1111 1000
0	000 0000 0000	010 0000 0000
0.125	000 0000 0001	010 0000 0001
1	000 0000 1000	010 0000 1000
64	010 0000 0000	100 0000 0000
65	010 0000 1000	100 0000 1000
127	011 1111 1000	101 1111 1000
127.875	011 1111 1111	101 1111 1111
128	011 1111 1111	110 0000 0000
190	011 1111 1111	111 1111 0000
191	011 1111 1111	111 1111 1000
>= 191.875	011 1111 1111	111 1111 1111

Chapter 6 Register Description

The registers shown in Table 6.1 are accessible through the SMBus. An entry of '-' indicates that the bit is not used and will always read '0'.

Table 6.1 Register Set in Hexadecimal Order

REGISTER ADDRESS	R/W	REGISTER NAME	FUNCTION	DEFAULT VALUE	PAGE
00h	R	Internal Diode Data High Byte	Stores the integer data for the Internal Diode	00h	Page 28
01h	R	External Diode 1 Data High Byte	Stores the integer data for External Diode 1	00h	raye 20
02h	R	Status	Stores the status bits for the Internal Diode and External Diodes	00h	Page 28
03h	R/W	Configuration	Controls the general operation of the device (mirrored at address 09h)	80h	Page 29
04h	R/W	Conversion Rate	Controls the conversion rate for updating temperature data (mirrored at address 0Ah)	06h (4/sec)	Page 30
05h	R/W	Internal Diode High Limit	Stores the 8-bit high limit for the Internal Diode (mirrored at address 0Bh)	55h (85°C)	
06h	R/W	Internal Diode Low Limit	Stores the 8-bit low limit for the Internal Diode (mirrored at address 0Ch)	00h (0°C)	Page 31
07h	R/W	External Diode 1 High Limit High Byte	Stores the integer portion of the high limit for External Diode 1 (mirrored at register 0Dh)	55h (85°C)	Tage 31
08h	08h R/W External Diode 1 Low Limit High Byte		Stores the integer portion of the low limit for External Diode 1 (mirrored at register 0Eh)	00h (0°C)	
09h	R/W	Configuration	Controls the general operation of the device (mirrored at address 03h)	80h	Page 29
0Ah	R/W	Conversion Rate	Controls the conversion rate for updating temperature data (mirrored at address 04h)	06h (4/sec)	Page 30